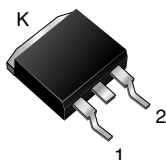


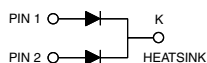
## Trench MOS Barrier Schottky Rectifier for PV Solar Cell Bypass Protection

Ultra Low  $V_F = 0.30\text{ V}$  at  $I_F = 5.0\text{ A}$

TMBS®  
TO-263AB



VBT3045CBP



### FEATURES

- Trench MOS Schottky technology
- Low forward voltage drop, low power losses
- High efficiency operation
- Meets MSL level 1, per J-STD-020, LF maximum peak of 245 °C
- Not recommended for PCB bottom side wave mounting
- Compliant to RoHS Directive 2002/95/EC and in accordance to WEEE 2002/96/EC



RoHS  
COMPLIANT

### TYPICAL APPLICATIONS

For use in solar cell junction box as a bypass diode for protection, using DC forward current without reverse bias.

### PRIMARY CHARACTERISTICS

$I_{F(AV)}$	2 x 15 A
$V_{RRM}$	45 V
$I_{FSM}$	200 A
$V_F$ at $I_F = 15\text{ A}$	0.39 V
$T_{OP\ max.}$	150 °C

### MECHANICAL DATA

**Case:** TO-263AB

Molding compound meets UL 94 V-0 flammability rating  
Base P/N-E3 - RoHS compliant, commercial grade

**Terminals:** Matte tin plated leads, solderable per J-STD-002 and JESD 22-B102

E3 suffix meets JESD 201 class 1A whisker test

**Polarity:** As marked

**Mounting Torque:** 10 in-lbs maximum

### MAXIMUM RATINGS ( $T_A = 25\text{ °C}$ unless otherwise noted)

PARAMETER	SYMBOL	VBT3045CBP	UNIT
Maximum repetitive peak reverse voltage	$V_{RRM}$	45	V
Maximum average forward rectified current (fig. 1)	$I_{F(AV)}$ <sup>(1)</sup>	per device	30
		per diode	15
Peak forward surge current 8.3 ms single half sine-wave superimposed on rated load per diode	$I_{FSM}$	200	A
Operating junction and storage temperature range	$T_{OP}, T_{STG}$	- 40 to + 150	°C
Junction temperature in DC forward current without reverse bias, $t \leq 1\text{ h}$	$T_J$ <sup>(2)</sup>	$\leq 200$	°C

#### Notes

<sup>(1)</sup> With heatsink

<sup>(2)</sup> Meets the requirements of IEC 61215 ed. 2 bypass diode thermal test

# VBT3045CBP

Vishay General Semiconductor



ELECTRICAL CHARACTERISTICS (T <sub>A</sub> = 25 °C unless otherwise noted)						
PARAMETER	TEST CONDITIONS		SYMBOL	TYP.	MAX.	UNIT
Instantaneous forward voltage per diode	I <sub>F</sub> = 5 A	T <sub>A</sub> = 25 °C	V <sub>F</sub> <sup>(1)</sup>	0.42	-	V
	I <sub>F</sub> = 7.5 A			0.44	-	
	I <sub>F</sub> = 15 A			0.49	0.57	
	I <sub>F</sub> = 5 A	T <sub>A</sub> = 125 °C		0.30	-	
	I <sub>F</sub> = 7.5 A			0.33	-	
	I <sub>F</sub> = 15 A			0.39	0.48	
Reverse current per diode	V <sub>R</sub> = 45 V	T <sub>A</sub> = 25 °C	I <sub>R</sub> <sup>(2)</sup>	-	2000	μA
		T <sub>A</sub> = 125 °C		17	50	mA

**Notes**

(1) Pulse test: 300 μs pulse width, 1 % duty cycle

(2) Pulse test: Pulse width ≤ 40 ms

THERMAL CHARACTERISTICS (T <sub>A</sub> = 25 °C unless otherwise noted)				
PARAMETER		SYMBOL	VBT3045CBP	UNIT
Typical thermal resistance	per diode	R <sub>θJC</sub>	1.6	°C/W
	per device		0.85	

ORDERING INFORMATION (Example)					
PACKAGE	PREFERRED P/N	UNIT WEIGHT (g)	PACKAGE CODE	BASE QUANTITY	DELIVERY MODE
TO-263AB	VBT3045CBP-E3/4W	1.38	4W	50/tube	Tube
TO-263AB	VBT3045CBP-E3/8W	1.38	8W	800/reel	Tape and reel

## RATINGS AND CHARACTERISTICS CURVES

(T<sub>A</sub> = 25 °C unless otherwise noted)

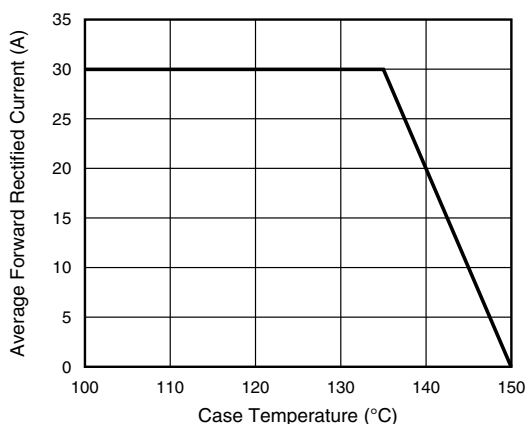


Fig. 1 - Maximum Forward Current Derating Curve

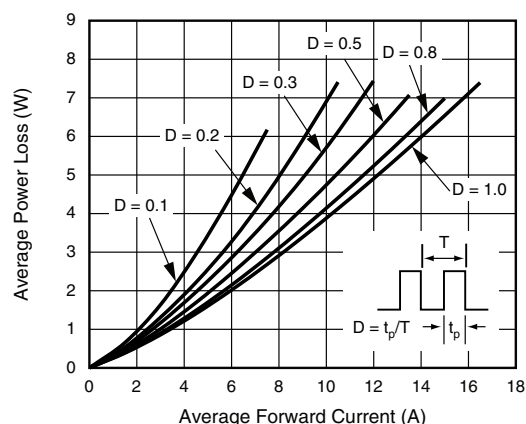


Fig. 2 - Forward Power Loss Characteristics Per Diode

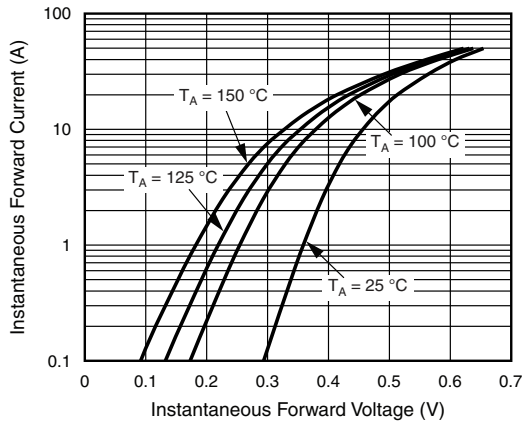


Fig. 3 - Typical Instantaneous Forward Characteristics Per Diode

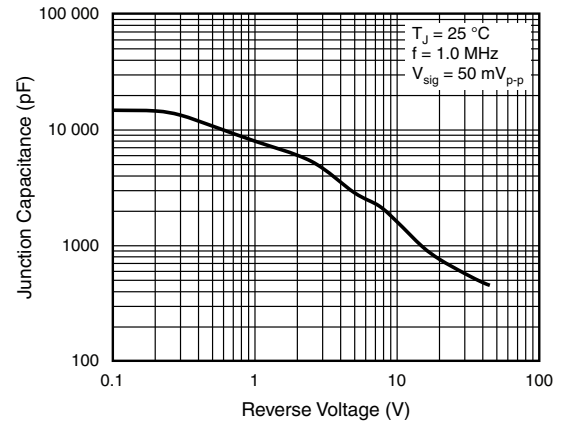


Fig. 5 - Typical Junction Capacitance Per Diode

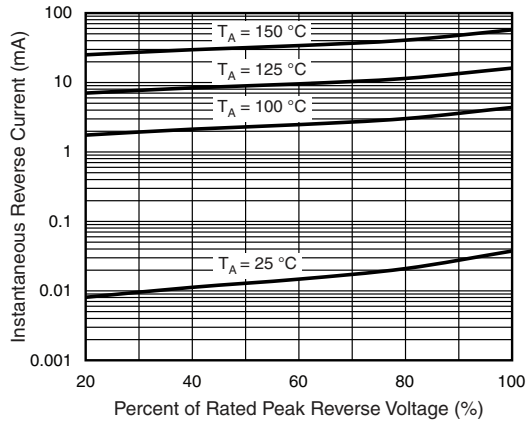


Fig. 4 - Typical Reverse Characteristics Per Diode

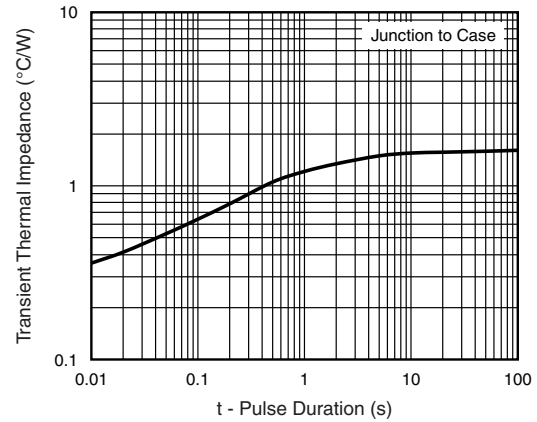
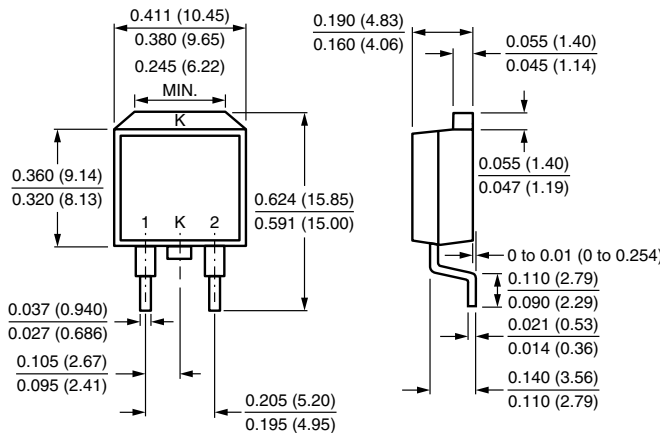


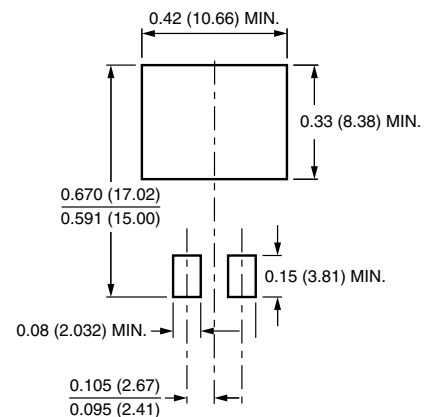
Fig. 6 - Typical Transient Thermal Impedance Per Diode

**PACKAGE OUTLINE DIMENSIONS** in inches (millimeters)

**TO-263AB**



**Mounting Pad Layout**





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